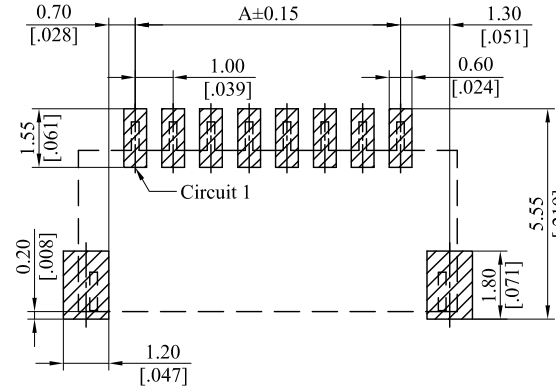
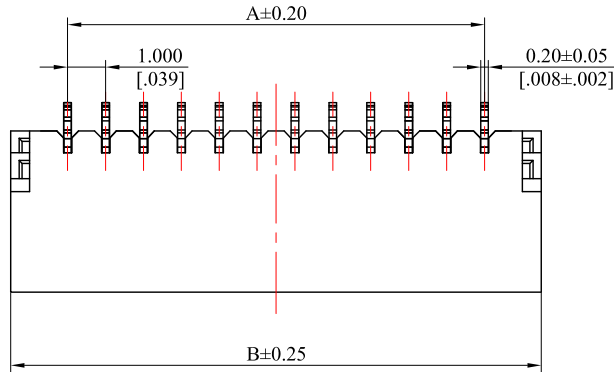


REV.	ECO. NO.	DESCRIPTION	DATE
A	DWG. REL.		
B	ES091222		
C	ES180822	B-2 Area: Change 1.00±0.05 to 1.000 D-4 Area: Change 0.700 to 0.75 Pin Material: Change Brass to Phosphor Bronze	2018.08.24
D	ES230611	B-6 Area: Add Specifications	2023.07.05



PCB LAYOUT

Note:

Material:

Insulator: High temperature Thermoplastic, UL94V-0, Natural  
Contact: Phosphor Bronze/Tin plated  
Solder Tabs: Brass/Tin plated

Specifications:

Current Rating: 1A AC/DC  
Voltage Rating: 50V AC/DC  
Temperature Rating:  $-25^{\circ}\text{C} \sim +85^{\circ}\text{C}$

General part number:

1010P \*\* MH00

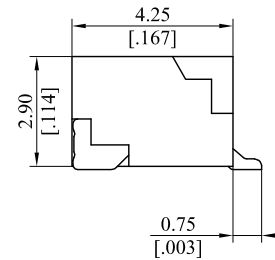
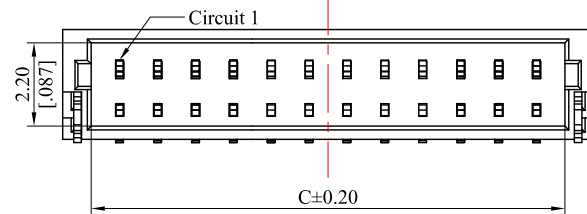
1

1.No. of circuits. (02~10)

$A = 1.00(.039 \text{ "})\text{mm} * \text{No. of Spaces}$

$B = A + 3.00(.118 \text{ "})\text{mm}$

$C = A + 1.50(.059 \text{ "})\text{mm}$



TOLERANCE UNLESS OTHERWISE SPECIFIED			LEOCO CORPORATION <a href="http://www.leoco.com.tw">http://www.leoco.com.tw</a>			
mm	mm	inch	APPROVED BY:	DATE:	TITLE:	
[inch]			Chard	2023.07.05	1.00mm Pitch SMT Wafer H Type	
1 PLACE	$\pm 0.30$	$\pm \text{---}$	CHECKED BY:	DATE:	PART NO.: 1010P**MH00	
2 PLACES	$\pm 0.20$	$\pm .012$	Merry	2023.07.05	DRAWING NO.: 101005S	
3 PLACES	$\pm 0.10$	$\pm .008$	SIZE: A3	SCALE: 1:1	REV.: D	SHEET: 1 OF 1
4 PLACES	$\pm \text{---}$	$\pm .004$	ANGULAR $\pm 1^{\circ}$			